

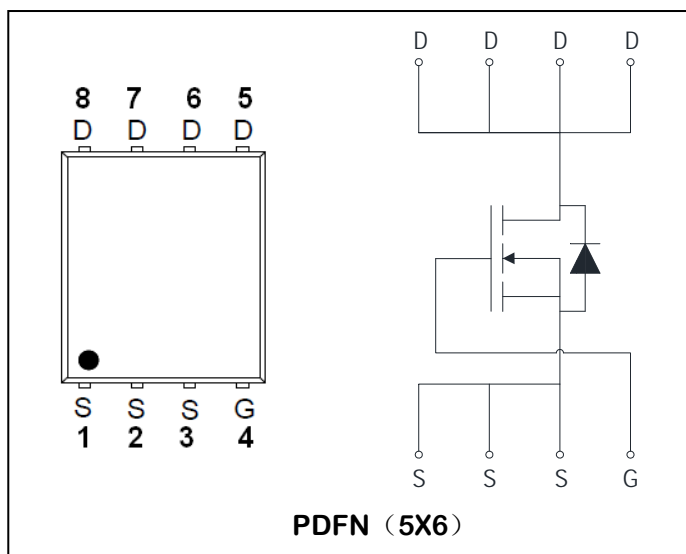
N-Channel Enhancement Mode Field Effect Transistor

PRODUCT SUMMARY

V_{DSS}	I_D	$R_{DS(ON)}$ (m Ω)
30V	90A	3.2m Ω

Features:

- Low Gate Charge for Fast Switching Application
- Low $R_{DS(ON)}$ to Minimize Conductive Loss
- 100% EAS Guaranteed
- Optimized $V_{(BR)DSS}$ Ruggedness
- Lead-Free,RoHS Compliant



Description:

The ADM90N03Q uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

Absolute Maximum Ratings ($T_A = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter		Ratings	Unit
Common Ratings				
V _{DSS}	Drain-Source Voltage		30	V
V _{GSS}	Gate-Source Voltage		±20	
T _J	Maximum Junction Temperature		150	°C
T _{STG}	Storage Temperature Range		-55 to150	°C
I _S	Diode Continuous Forward Current	T _C =25°C	90	A
Mounted on Large Heat Sink				
I _{DM}	300μs Pulse Drain Current Tested ⁽²⁾	T _C =25°C	360	A
I _D	Continuous Drain Current ⁽¹⁾	T _C =25°C	90	A
		T _C =100°C	59	A
P _D	Maximum Power Dissipation	T _A = 25°C	39	W

Thermal Characteristics

Symbol	Parameter	Ratings	Unit
R_{thJC}	Thermal resistance junction-case max ⁽¹⁾	3.2	$^\circ\text{C/W}$
R_{thJA}	Thermal resistance junction-ambient max ⁽¹⁾	70	$^\circ\text{C/W}$

Electrical Characteristics (TA=25°C Unless Otherwise Noted)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
On/off Characteristics						
V(BR)DSS	Drain-Source Breakdown Voltage	VGS=0V, IDS=250uA	30	--	--	V
IDSS	Zero Gate Voltage Drain Current	VDS=30V,VGS=0V , TJ=25°C	--	--	1	uA
VGS(th)	Gate Threshold Voltage	VDS=VGS, IDS=250uA	1	1.6	2.5	V
IGSS	Gate Leakage Current	VGS=±20V, VDS=0V	--	--	±100	nA
RDS(ON)	Drain-SourceOn-stateResistance ⁽²⁾	VGS= 10V, IDS=30A	--	2.4	3.2	mΩ
		VGS= 4.5V, IDS=20A	--	4.5	6.2	
Dynamic Characteristics						
Ciss	Input Capacitance	VGS=0V, VDS=15V, Frequency=1MHz	--	3500	--	pF
Coss	Output Capacitance		--	500	--	
Crss	Reverse Transfer Capacitance		--	431	--	
Switching Characteristics						
td(ON)	Turn-on Delay Time	VDS=15V, ID= 30A, VGS= 10V, RGEN=3 Ω	--	26	--	nS
tr	Turn-on Rise Time		--	24	--	
td(OFF)	Turn-off Delay Time		--	91	--	
tf	Turn-off Fall Time		--	39	--	
Qg	Total Gate Charge	VDS=15V, VGS= 10V, IDS=30A	--	38	--	nC
Qgs	Gate-Source Charge		--	9	--	
Qgd	Gate-Drain Charge		--	13	--	
Avalanche Characteristics						
EAS	Single Pulse Avalanche Energy ⁽³⁾	VDD=15V,L=0.5mH ,VGS=1 0V,Rg=25 Ω , IAS=30A TJ=25°C	80	--	--	mJ
Diode Characteristics						
VSD	Diode Forward Voltage ⁽²⁾	ISD = 30A, VGS = 0	--	--	1.2	V
trr	Reverse Recovery Time	ISD=20A, dISD/dt=100A/μs	--	42	--	ns
qrr	Reverse Recovery Charge		--	39	--	nC

NOTES:

1. Surface Mounted on FR4 Board, t ≤ 10 sec.
2. The data tested by pulsed , pulse width ≤ 300us , duty cycle ≤ 2%
3. The Min. value is 100% EAS tested guarantee.

Typical Performance Characteristics

Figure1: Output Characteristics

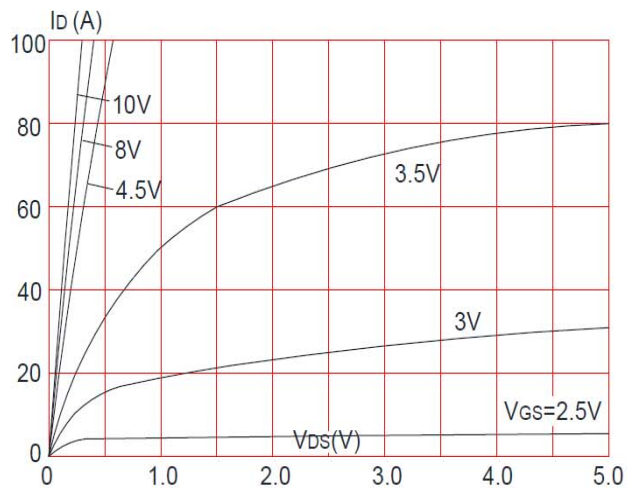


Figure 2: Typical Transfer Characteristics

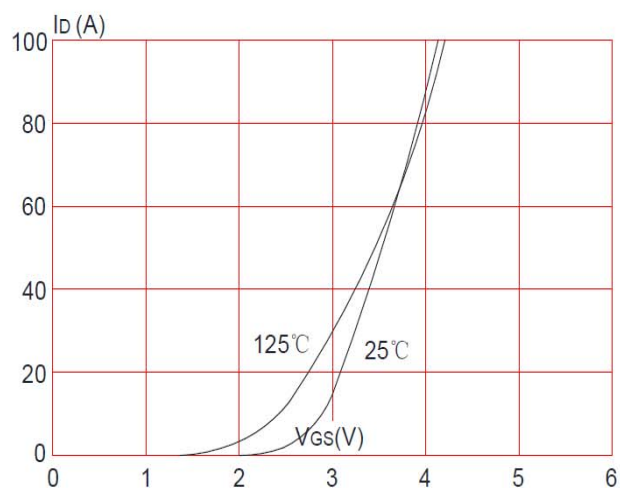


Figure 3: On-resistance vs. Drain Current

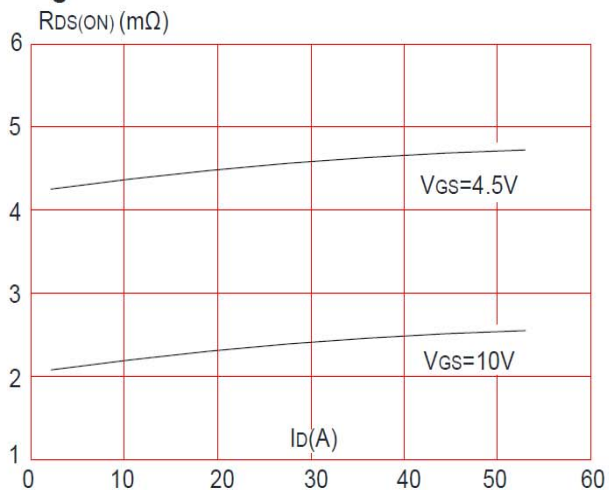


Figure 4: Body Diode Characteristics

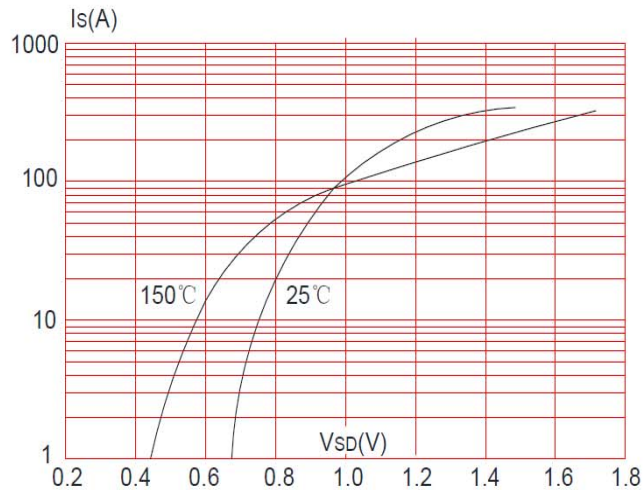


Figure 5: Gate Charge Characteristics

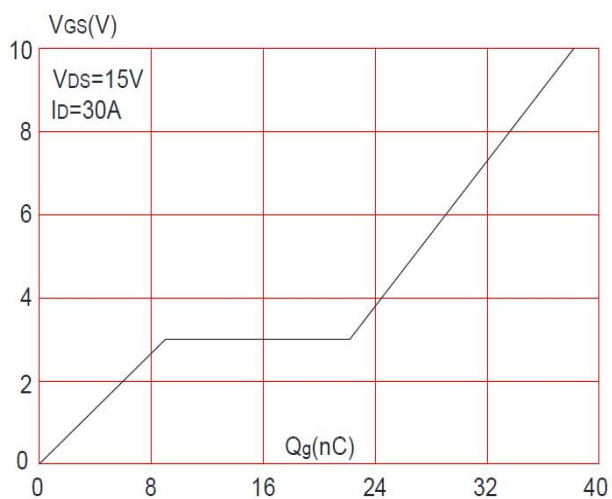


Figure 6: Capacitance Characteristics

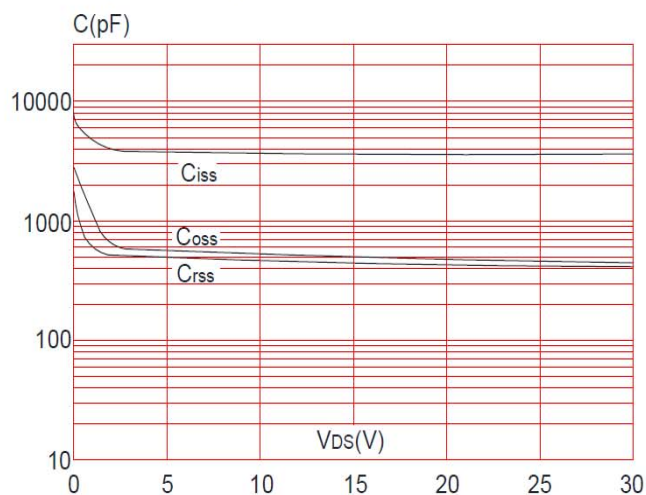


Figure 7: Normalized Breakdown Voltage vs. Junction Temperature

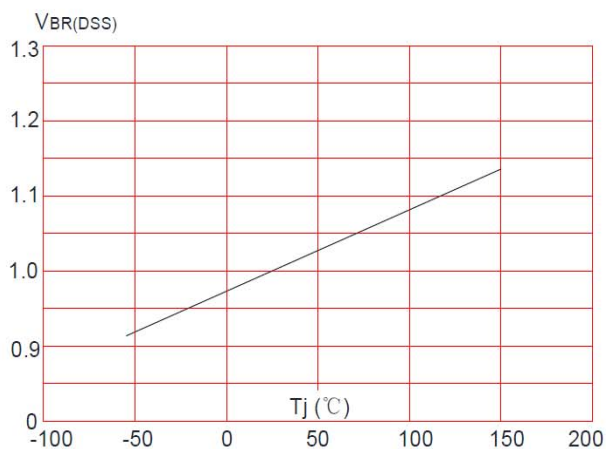


Figure 8: Normalized on Resistance vs. Junction Temperature

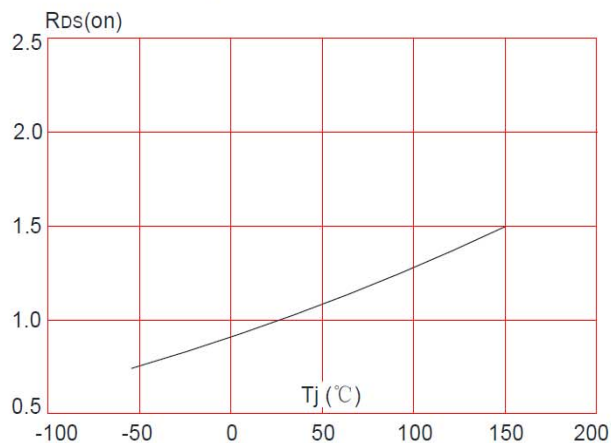


Figure 9: Maximum Safe Operating Area

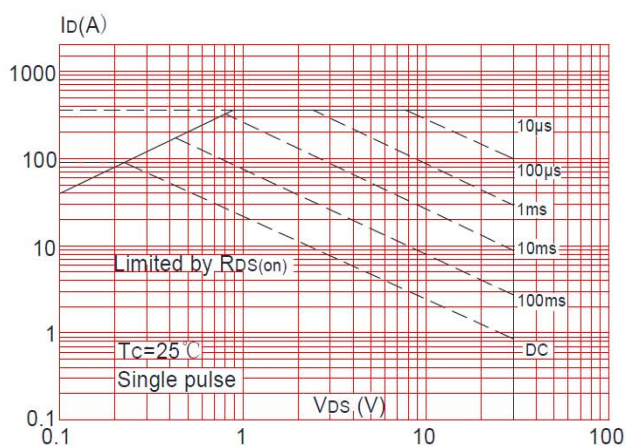


Figure 10: Maximum Continuous Drain Current vs. Case Temperature

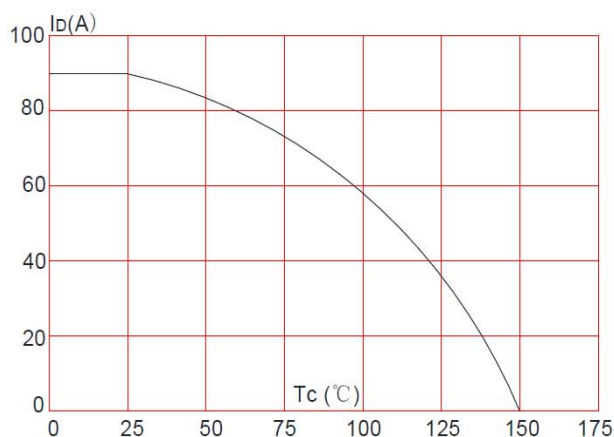


Figure.11: Maximum Effective Transient Thermal Impedance, Junction-to-Case

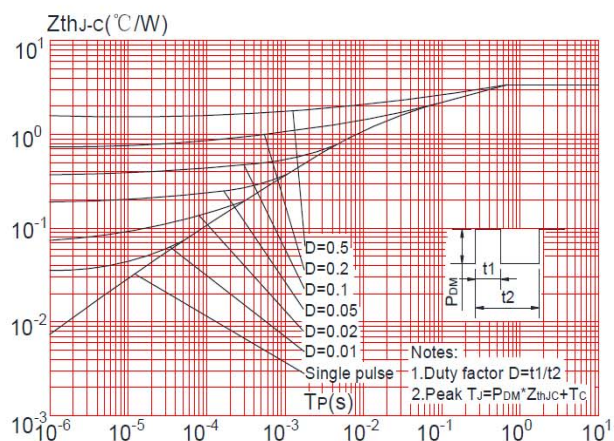


Figure 12: Switching Time Waveform

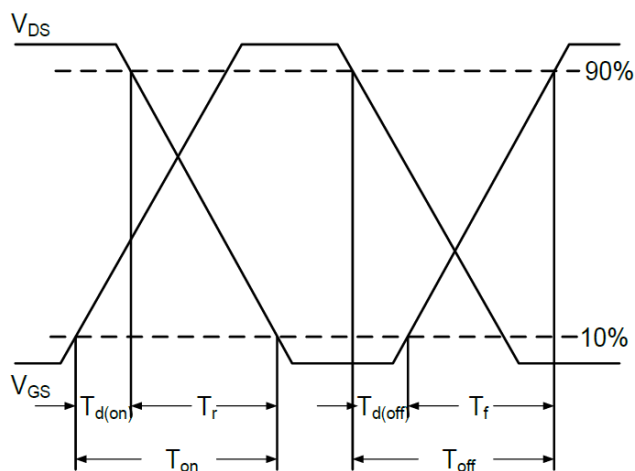
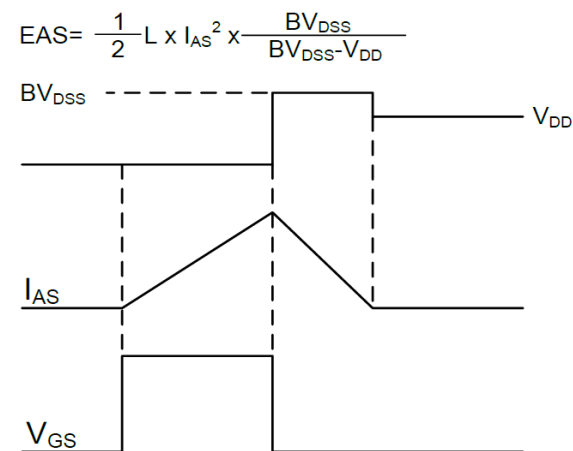
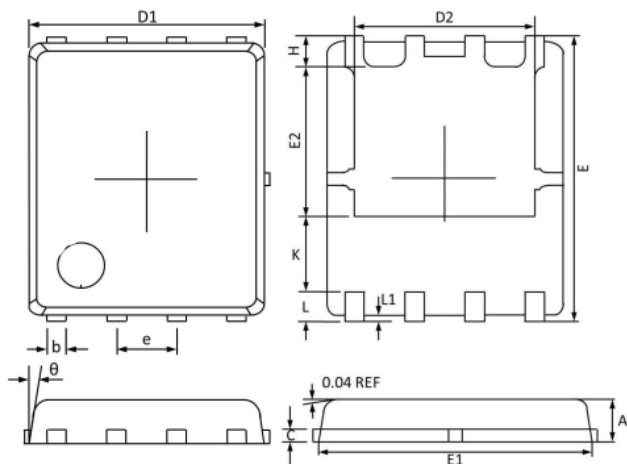


Figure 13: EAS Waveform



PACKAGE MECHANICAL DATA
PDFN (5X6) Package Dimension



Symb ol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.800	1.100	0.031	0.043
b	0.330	0.510	0.013	0.020
c	0.200	0.300	0.008	0.012
D1	4.800	5.100	0.189	0.201
D2	3.610	4.100	0.142	0.161
E	5.900	6.200	0.232	0.244
E1	5.700	5.900	0.224	0.232
E2	3.350	3.780	0.132	0.149
H	0.410	0.700	0.016	0.028
K	1.100	1.500	0.043	0.059
e	1.270 TYP.		0.050 TYP.	
L	0.510	0.710	0.020	0.028
L1	0.060	0.200	0.002	0.008
θ	0°	12°	0°	12°

Ordering information

Part number	Package	Marking	Packing	Quantity
ADM90N03Q	PDFN5*3	M90N03Q	Embossed tape	2500pcs

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